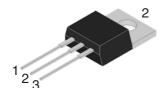
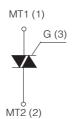


#### **TO-220AB**





#### **On-State Current**

#### **Gate Trigger Current**

16 Amp

< 10 mA

#### **Off-State Voltage**

400 V ÷ 800 V

#### **FEATURES**

- Glass/passivated die junctions
- Medium current Triac
- Ideal for automated placement
- Low thermal resistance
- High surge current capability
- Low forward voltage drop
- Solder dip 260°C, 10s
- Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC
- Meets MSL level 3, per J-STD-020, LF maximum peak of 260° C

#### **MECHANICAL DATA**

- Case: TO-220AB. Epoxy meets UL 94V-0 flammability rating.
- **Polarity:** As marked on the body.
- **Terminals:** Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test.

#### TYPICAL APPLICATIONS

Logic level versions are designed to interface directly with low power drivers such as microcontrollers.

### Maximun Ratings and Electrical Characteristics at 25°C

SYMBOL	PARAMETER	CONDITIONS	Value	Unit
I <sub>T(RMS)</sub>	RMS On-state Current (full sine wave)	All Conduction Angle, T <sub>c</sub> =9 5 °C	16	А
I <sub>TSM</sub>	Non-repetitive On-State Current	Full Cycle, 60 Hz (t = 16.7 ms)	176	А
I <sub>TSM</sub>	Non-repetitive On-State Current	Full Cycle, 50 Hz (t = 20 ms)	160	А
I <sup>2</sup> t	Fusing Current	tp = 10 ms, Half Cycle	144	A <sup>2</sup> s
I <sub>GM</sub>	Peak Gate Current	20 μs max. Tj = 125 °C	4	А
$P_{G(AV)}$	Average Gate Power Dissipation	Tj = 125 °C	1	W
dI/dt	Critical rate of rise of on-state current	$I_G = 2x I_{GT}, t_r \le 100 \text{ns}$	50	A/µs
		f = 120 Hz, T <sub>j</sub> = 125 °C		
T <sub>j</sub>	Operating Temperature		(-40 +125)	°C
T <sub>stg</sub>	Storage Temperature		(-40 +150)	°C
T <sub>sld</sub>	Soldering Temperature	10s max	260	°C

SYMBOL	PARAMETER		Unit		
01202		D	M	N	Oilit
$V_{DRM}/V_{RRM}$	Repetitive Peak Off State Voltage	400	600	800	V

Revision: 1

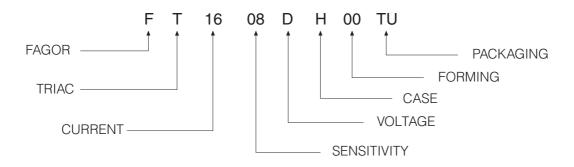


### Electrical Characteristics at Tamb = 25 °C

SYMBOL	PARAMETER	CONDITIONS		Quadrant		SENSITIVITY 08	Unit
I <sub>GT</sub> <sup>(1)</sup>	Gate Trigger Current	$V_D = 12 V_{DC}, R_L = 33\Omega,  T$	_j = 25 °C	Q1÷Q3	MAX	10	mA
				Q4	MAX		mA
V <sub>GT</sub>	Gate Trigger Voltage	$V_D = 12  V_{DC},  R_L = 33 \Omega,  T$	<sub>j</sub> = 25 °C	Q1÷Q3	MAX	1.3	V
				Q1÷Q4	MAX		V
V <sub>GD</sub>	Gate Non Trigger Voltage	$V_D = V_{DRM}, R_L = 3.3\; K\Omega, T_j$	= 125 °C	Q1÷Q3	MIN	0.2	V
				Q1÷Q4	MIN		V
I <sub>H</sub> <sup>(2)</sup>	Holding Current	$I_T = 100 \text{ mA}$ , Gate open, T	j = 25 °C		MAX	15	mA
IL	Latching Current	$I_G = 1.2 I_{GT}, T_j = 25 ^{\circ}\text{C}$		Q1,Q3	MAX	25	mA
				Q1,Q3,Q4	MAX		mA
				Q2	MAX	30	mA
dV/dt <sup>(2)</sup>	Critical Rate of Voltage Rise	$V_D = 0.67 \times V_{DRM}$ , Gate ope	en		MIN	40	V/µs
		T <sub>j</sub> = 125 °C					
(dl/dt)c (2)	Critical Rate of Current Rise	$(dv/dt)c = 0.1 V/\mu s$ $T_j = 0.1 V/\mu s$	= 125 °C		MIN	8.5	A/ms
		$(dv/dt)c = 10 V/\mu s$ $T_j = 0$	= 125 °C		MIN	3.0	A/ms
		without snubber $T_j$ :	= 125 °C		MIN	-	
V <sub>TM</sub> <sup>(2)</sup>	On-state Voltage	$I_T = 22.5 \text{ Amp, tp} = 380 \mu \text{s,T}$	<sub>j</sub> = 25 °C		MAX	1.6	V
V <sub>t (o)</sub> (2)	Threshold Voltage	$T_j = 125 ^{\circ}\text{C}$			MAX	0.85	V
r <sub>d</sub> <sup>(2)</sup>	Dynamic resistance	T <sub>j</sub> = 125 °C			MAX	25	mΩ
I <sub>DRM</sub> /I <sub>RRM</sub>	Off-State Leakage Current	$V_D = V_{DRM},$ $T_j = 0$	= 125 °C		MAX	2	mA
		$V_R = V_{RRM},$ T	j = 25 °C		MAX	5	μΑ
R <sub>th(j-c)</sub>	Thermal Resistance	for AC 360° conduction an	gle			1.1	°C/W
	Junction-Case						
R <sub>th(j-a)</sub>	Thermal Resistance						
	Junction-Ambient					60	°C/W

<sup>(1)</sup> Minimum  $I_{\mbox{\scriptsize GT}}$  is guaranted at 5% of  $I_{\mbox{\scriptsize GT}}$  max.

### **Part Number Information**



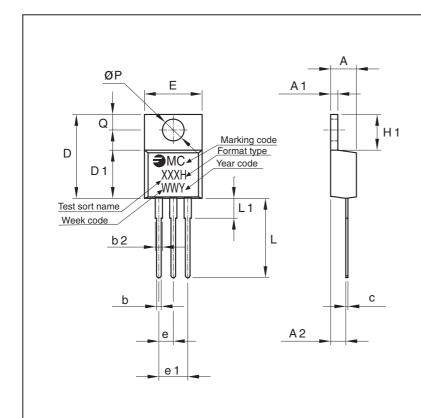
<sup>(2)</sup> For either polarity of electrode MT2 voltage with reference to electrode MT1.



# **Ordering information**

PREFERRED P/N	PACKAGE CODE	DELIVERY MODE	BASE QUANTITY	UNIT WEIGHT (g)
FT1608MH 00TU	TU	TUBE	1,000	2.30

## Package Outline Dimensions: (mm) TO-220AB



	DIMENSIONS			
REF.	Milimeters			
	Min.	Max.		
А	4.47	4.67		
A1	1.17	1.37		
A2	2.52	2.82		
b	0.71	0.91		
b2	1.17	1.37		
С	0.31	0.53		
D	14.65	15.35		
D1	8.50	8.90		
Ε	10.01	10.36		
е	2.51	2.57		
e1	4.98	5.18		
H1	6.15	6.45		
L	13.40	13.96		
L1	3.56	3.96		
Р	3.735	3.935		
Q	2.59	2.89		

Mounting Torque 0.8 N.m



# Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 1: Maximum power dissipation versus RMS on-state current (full cycle).

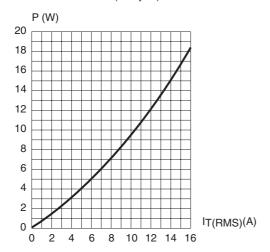


Fig. 3: Relative variation of thermal impedance versus pulse duration.

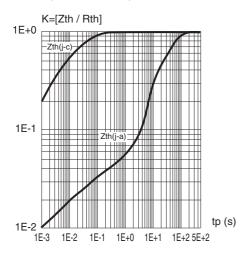


Fig. 5: Surge peak on-state current versus number of cycles

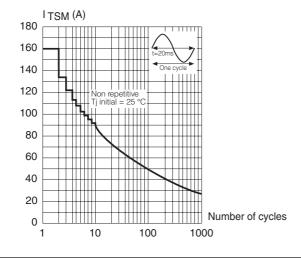


Fig. 2: RMS on-state current versus case temperature (full cycle).

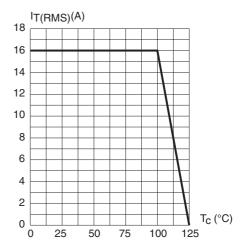


Fig. 4: On-state characteristics (maximum values)

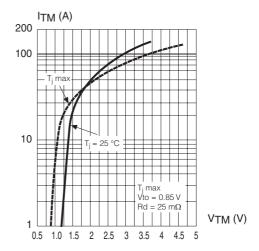
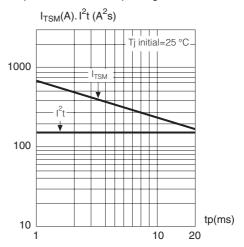


Fig. 6: Non repetitive surge peak on-state current for a sinusoidal pulse with width: tp < 10 ms, and corresponding value of  $l^2t$ .





# Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 7: Relative variation of gate trigger current, holding current and latching versus junction temperature (typical values)

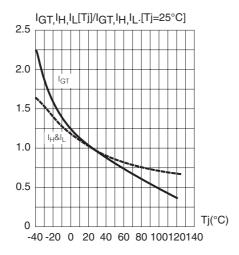


Fig. 9: Relative variation of critical rate of decrease of main current versus

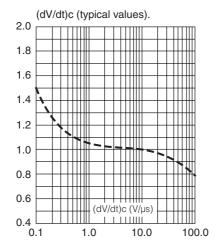
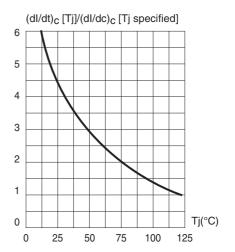


Fig. 8: Relative variation of critical rate of decrease of main current versus junction temperature





#### **Revision History**

Date	Revision	Description of Changes
Jun-2011	0	Original Data Sheet
22-Jun-2017 1		200V and 700V eliminated

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